



# STGB10NB37LZ

## N-CHANNEL CLAMPED 20A - D2PAK INTERNALLY CLAMPED PowerMesh™ IGBT

TYPE	V <sub>CES</sub>	V <sub>CE(sat)</sub>	I <sub>C</sub>
STGB10NB37LZ	CLAMPED	< 1.8 V	20 A

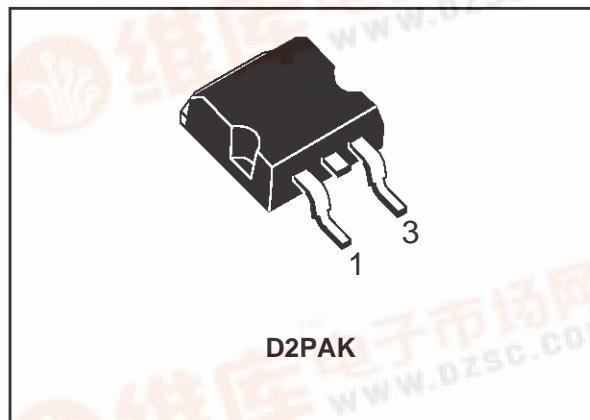
- POLYSILICON GATE VOLTAGE DRIVEN
- LOW THRESHOLD VOLTAGE
- LOW ON-VOLTAGE DROP
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- HIGH VOLTAGE CLAMPING FEATURE

### DESCRIPTION

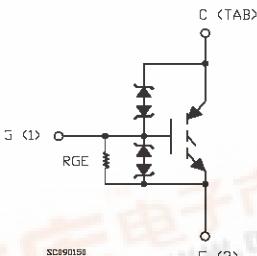
Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The built in collector-gate zener exhibits a very precise active clamping while the gate-emitter zener supplies an ESD protection.

### APPLICATIONS

- AUTOMOTIVE IGNITION



### INTERNAL SCHEMATIC DIAGRAM



### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage (V <sub>GS</sub> = 0)	CLAMPED	V
V <sub>ECR</sub>	Reverse Battery Protection	18	V
V <sub>GE</sub>	Gate-Emitter Voltage	CLAMPED	V
I <sub>C</sub>	Collector Current (continuos) at T <sub>C</sub> = 100°C	20	A
I <sub>CM</sub>	Collector Current (pulse width < 100μs)	60	A
P <sub>TOT</sub>	Total Dissipation at T <sub>C</sub> = 25°C	125	W
	Derating Factor	0.83	W/°C
E <sub>SD</sub>	ESD (Human Body Model)	4	kV
T <sub>stg</sub>	Storage Temperature	-65 to 175	°C
T <sub>j</sub>	Max. Operating Junction Temperature	175	°C

## STGB10NB37LZ

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### THERMAL DATA

Rthj-case	Thermal Resistance Junction-case Max	1.2	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	62.5	°C/W
Rthc-sink	Thermal Resistance Case-sink Typ	0.2	°C/W

### ELECTRICAL CHARACTERISTICS (TCASE = 25 °C UNLESS OTHERWISE SPECIFIED) OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BV(CES)	Clamped Voltage	I <sub>C</sub> = 2 mA, V <sub>GE</sub> = 0, T <sub>j</sub> = - 40°C to 150°C	375	400	425	V
BV(ECR)	Emitter Collector Break-down Voltage	I <sub>EC</sub> = 75 mA, V <sub>GE</sub> = 0, T <sub>j</sub> = - 40°C to 150°C	18			V
BV <sub>GE</sub>	Gate Emitter Break-down Voltage	I <sub>G</sub> = ± 2 mA T <sub>j</sub> = - 40°C to 150°C	12		16	V
I <sub>CES</sub>	Collector cut-off Current (V <sub>GE</sub> = 0)	V <sub>CE</sub> = 15 V, V <sub>GE</sub> =0 ,T <sub>j</sub> =150 °C V <sub>CE</sub> =200 V, V <sub>GE</sub> =0 ,T <sub>C</sub> =150°C			10 100	μA μA
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ± 10 V , V <sub>CE</sub> = 0			± 700	μA
R <sub>GE</sub>	Gate Emitter Resistance			20		KΩ

### ON (1)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>GE(th)</sub>	Gate Threshold Voltage	V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA, T <sub>j</sub> = - 40°C to 150°C	0.6		2.4	V
V <sub>CE(SAT)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =4.5V, I <sub>C</sub> = 10 A, T <sub>j</sub> = 25°C V <sub>GE</sub> =4.5V, I <sub>C</sub> = 10 A, T <sub>c</sub> = -40°C		1.2 1.3	1.8	V V
I <sub>C</sub>	Collector Current	V <sub>GE</sub> = 4.5V, V <sub>CE</sub> = 9 V	20			A

### DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g <sub>fs</sub>	Forward Transconductance	V <sub>CE</sub> = 15 V , I <sub>C</sub> =20 A		18		S
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> = 25V, f = 1 MHz, V <sub>GE</sub> = 0		1250		pF
C <sub>oes</sub>	Output Capacitance			103		pF
C <sub>res</sub>	Reverse Transfer Capacitance			18		pF
Q <sub>g</sub>	Gate Charge	V <sub>CE</sub> = 320V, I <sub>C</sub> = 10 A, V <sub>GE</sub> = 5V		28		nC

**FUNCTIONAL CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_L$	Latching Current	$V_{Clamp} = 320 \text{ V}$ , $T_C = 125^\circ\text{C}$ $R_{GOFF} = 1\text{K}\Omega$ , $V_{GE} = 5 \text{ V}$ $L = 300\mu\text{H}$	20			A
U.I.S.	Unclamped Inductive Switching Current	$R_{GOFF} = 1\text{K}\Omega$ , $L = 1.6 \text{ mH}$ , $T_c = 125^\circ\text{C}$ , $V_{cc} = 30\text{V}$	15			A

**SWITCHING ON**

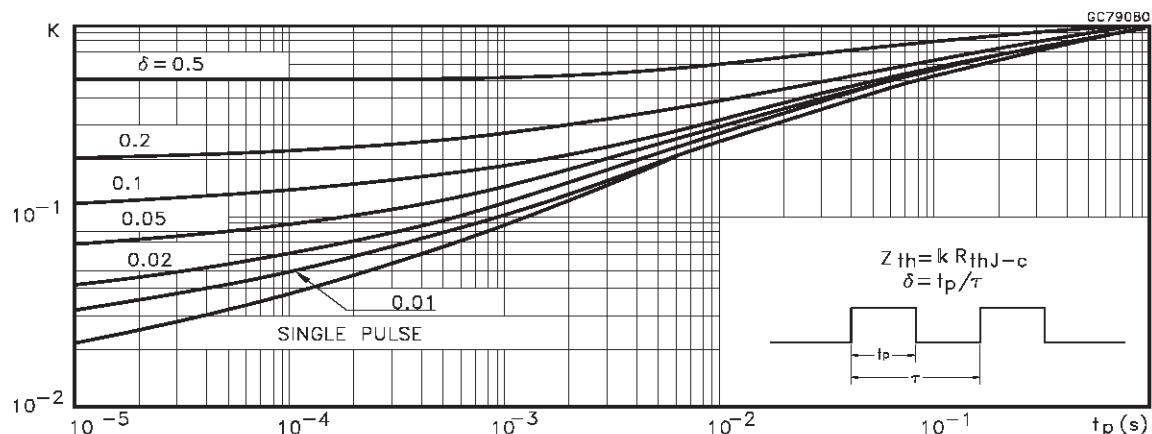
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 320 \text{ V}$ , $I_C = 10 \text{ A}$		520		ns
$t_r$	Rise Time	$R_G = 1\text{K}\Omega$ , $V_{GE} = 5 \text{ V}$		340		ns
$(di/dt)_{on}$ Eon	Turn-on Current Slope Turn-on Switching Losses	$V_{CC} = 320 \text{ V}$ , $I_C = 10 \text{ A}$ $R_G = 1\text{K}\Omega$ , $V_{GE} = 5 \text{ V}$		17 180		$\text{A}/\mu\text{s}$ $\mu\text{J}$

**SWITCHING OFF**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_c$	Cross-over Time	$V_{Clamp} = 320 \text{ V}$ , $I_C = 10 \text{ A}$ ,		4		$\mu\text{s}$
$t_r(V_{off})$	Off Voltage Rise Time	$R_{GE} = 1\text{K}\Omega$ , $V_{GE} = 5 \text{ V}$		2.2		$\mu\text{s}$
$t_d(off)$	Delay Time			14.8		$\mu\text{s}$
$t_f$	Fall Time			1.5		$\mu\text{s}$
$E_{off}^{(**)}$	Turn-off Switching Loss			4.0		$\text{mJ}$
$t_c$	Cross-over Time	$V_{Clamp} = 320 \text{ V}$ , $I_C = 10 \text{ A}$ ,		5.2		$\mu\text{s}$
$t_r(V_{off})$	Off Voltage Rise Time	$R_{GE} = 1\text{K}\Omega$ , $V_{GE} = 5 \text{ V}$		2.8		$\mu\text{s}$
$t_d(off)$	Delay Time	$T_j = 125^\circ\text{C}$		15.8		$\mu\text{s}$
$t_f$	Fall Time			2		$\mu\text{s}$
$E_{off}^{(**)}$	Turn-off Switching Loss			6.5		$\text{mJ}$

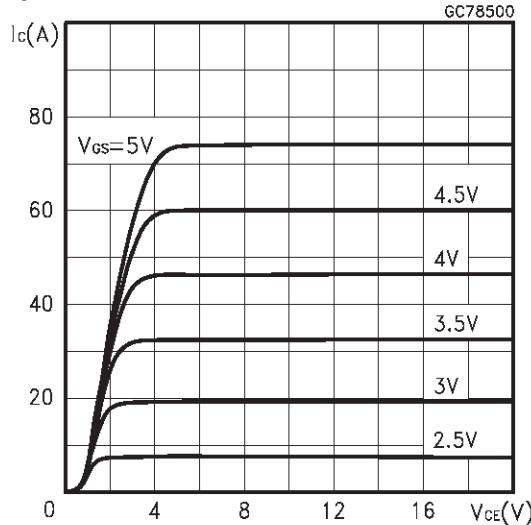
(●)Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5 %. (1)Pulse width limited by max. junction temperature. (\*\*)Losses Include Also the Tail

**Normalized Transient Thermal Impedance**

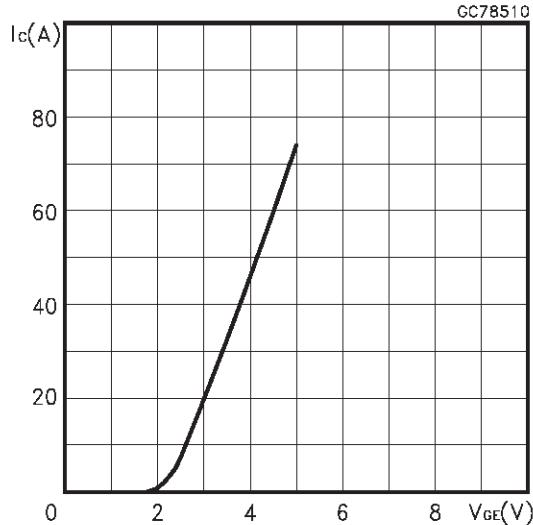


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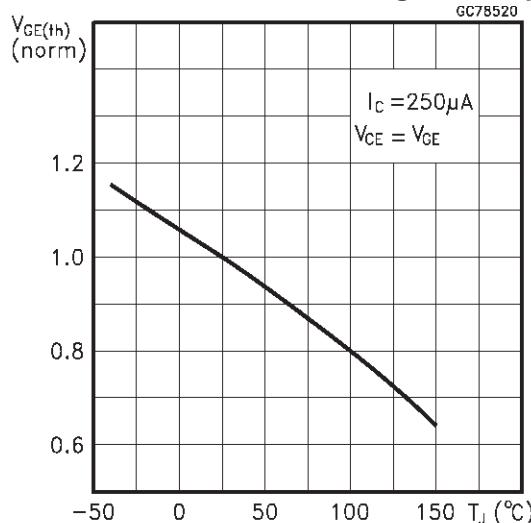
### Output Characteristics



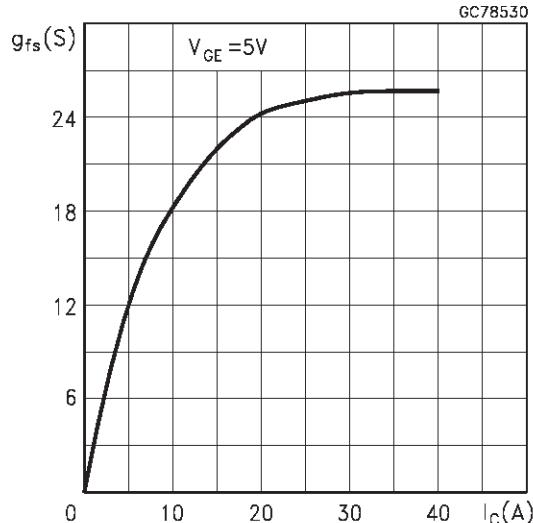
### Transfer Characteristics



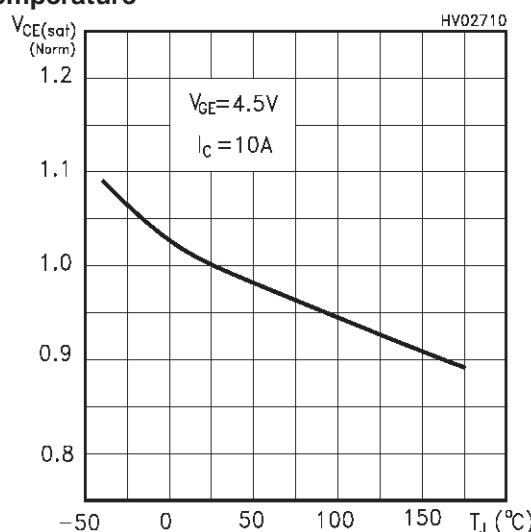
### Normalized Gate Threshold Voltage vs Temp.



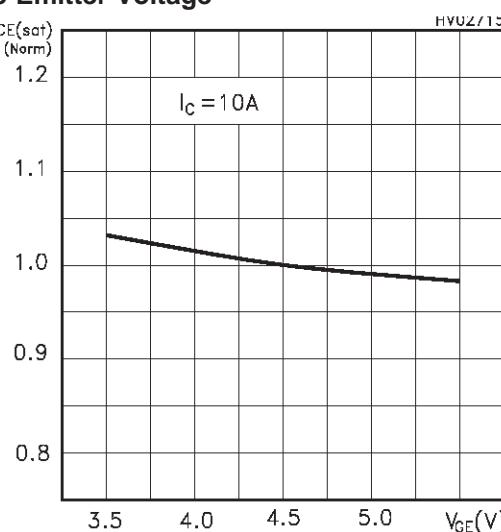
### Transconductance



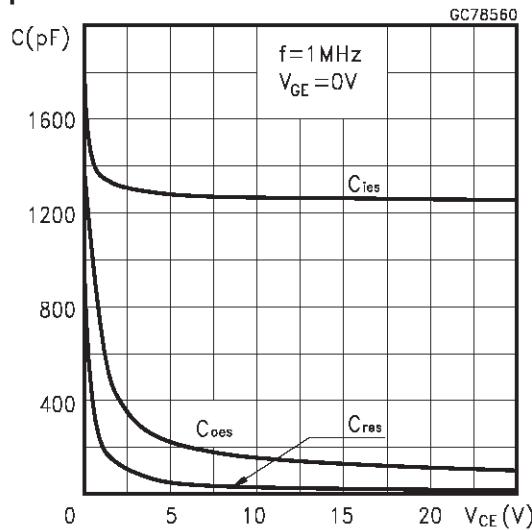
### Normalized Collector-Emitter On Voltage vs Temperature



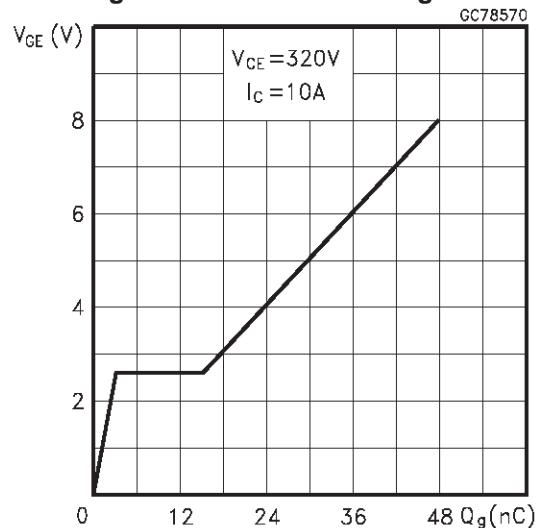
### Normalized Collector-Emitter On Voltage vs Gate-Emitter Voltage



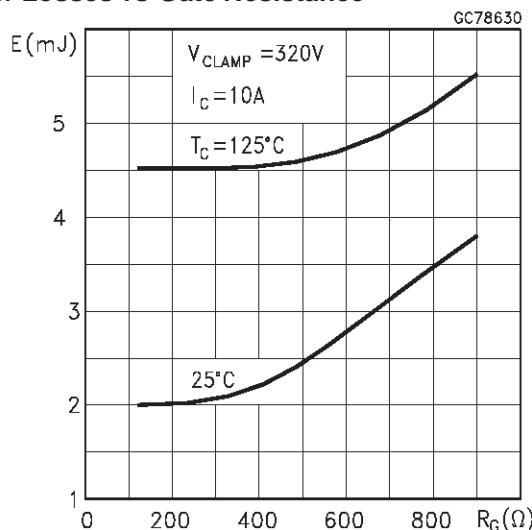
**Capacitance Variations**



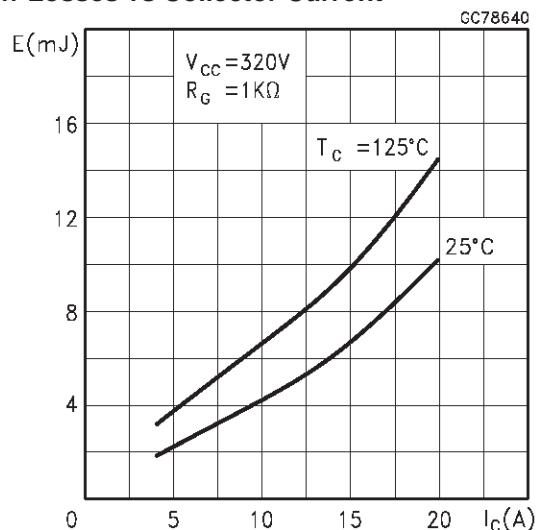
**Gate Charge vs Gate-Emitter Voltage**



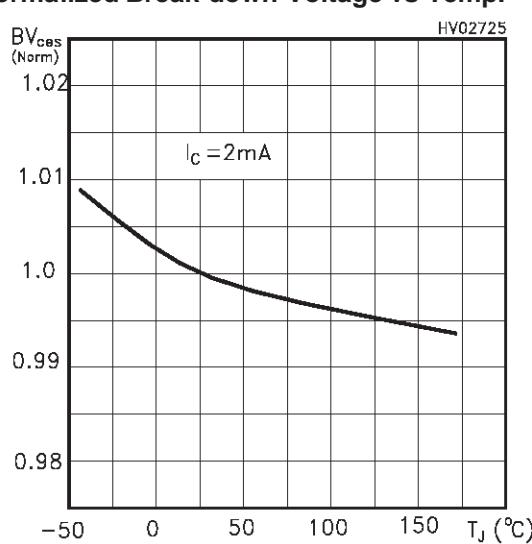
**Off Losses vs Gate Resistance**



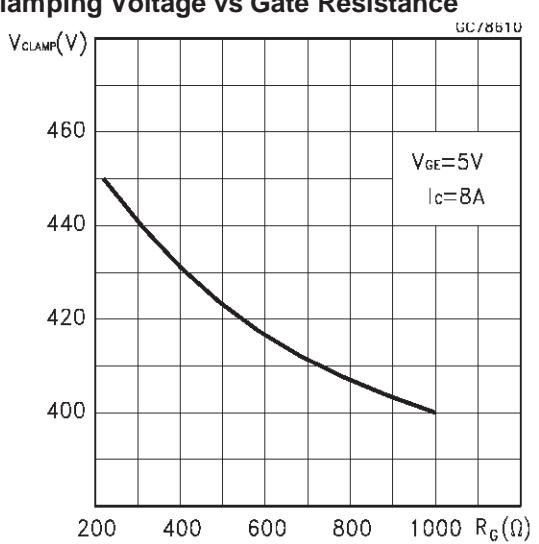
**Off Losses vs Collector Current**



**Normalized Break-down Voltage vs Temp.**



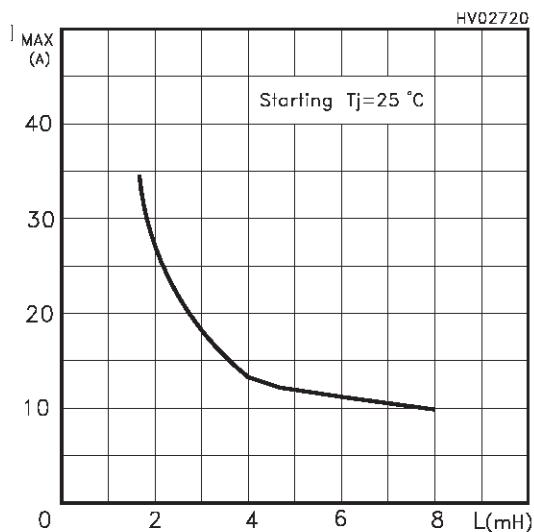
**Clamping Voltage vs Gate Resistance**



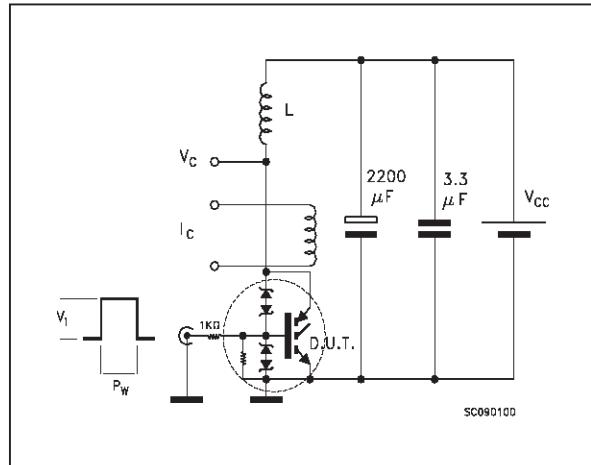
## STGB10NB37LZ

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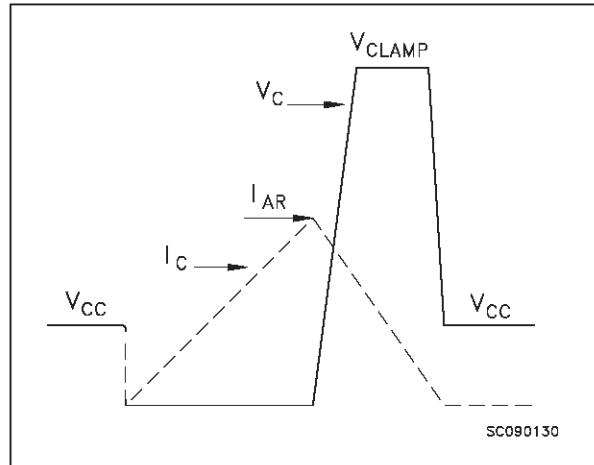
### Self Clamped Inductive Switching IMAX vs Open Secondary Coil



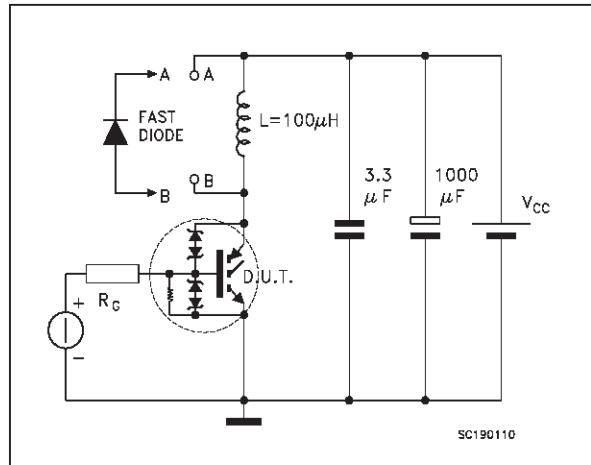
**Fig. 1:** Unclamped Inductive Load Test Circuit



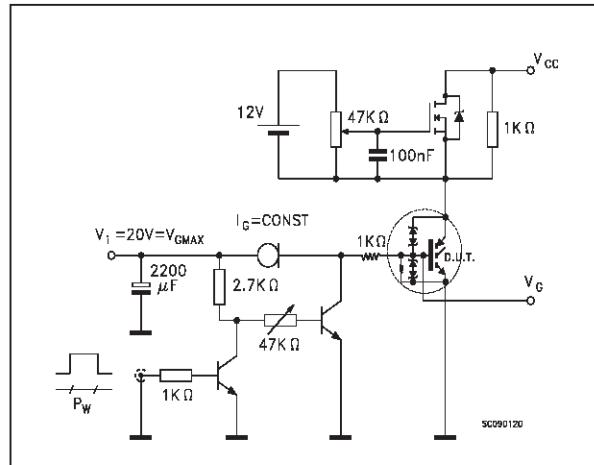
**Fig. 2:** Unclamped Inductive Waveform



**Fig. 3:** Test Circuit For Inductive Load Switching And Diode Recovery Times



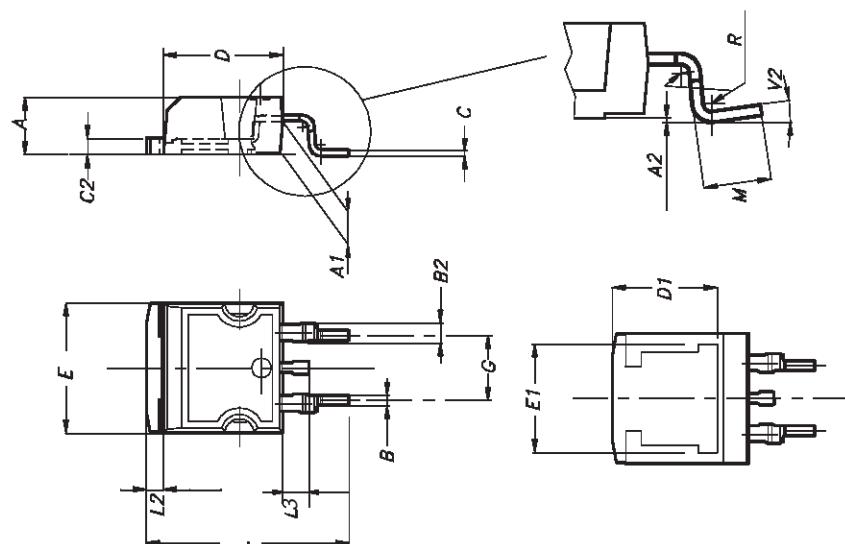
**Fig. 4:** Gate Charge test Circuit

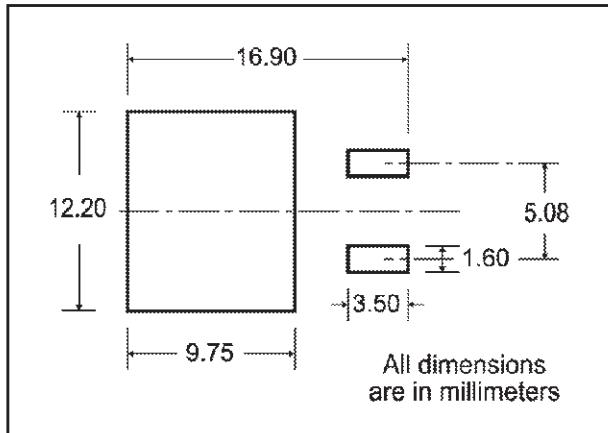
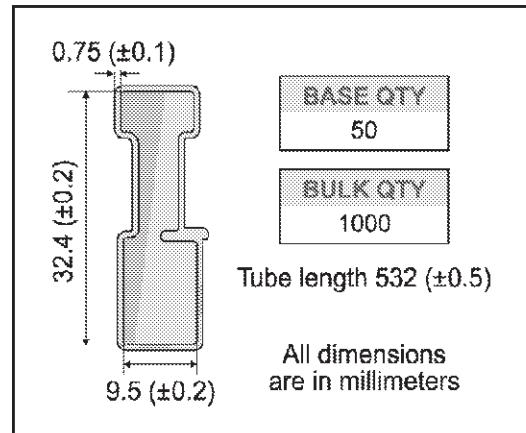
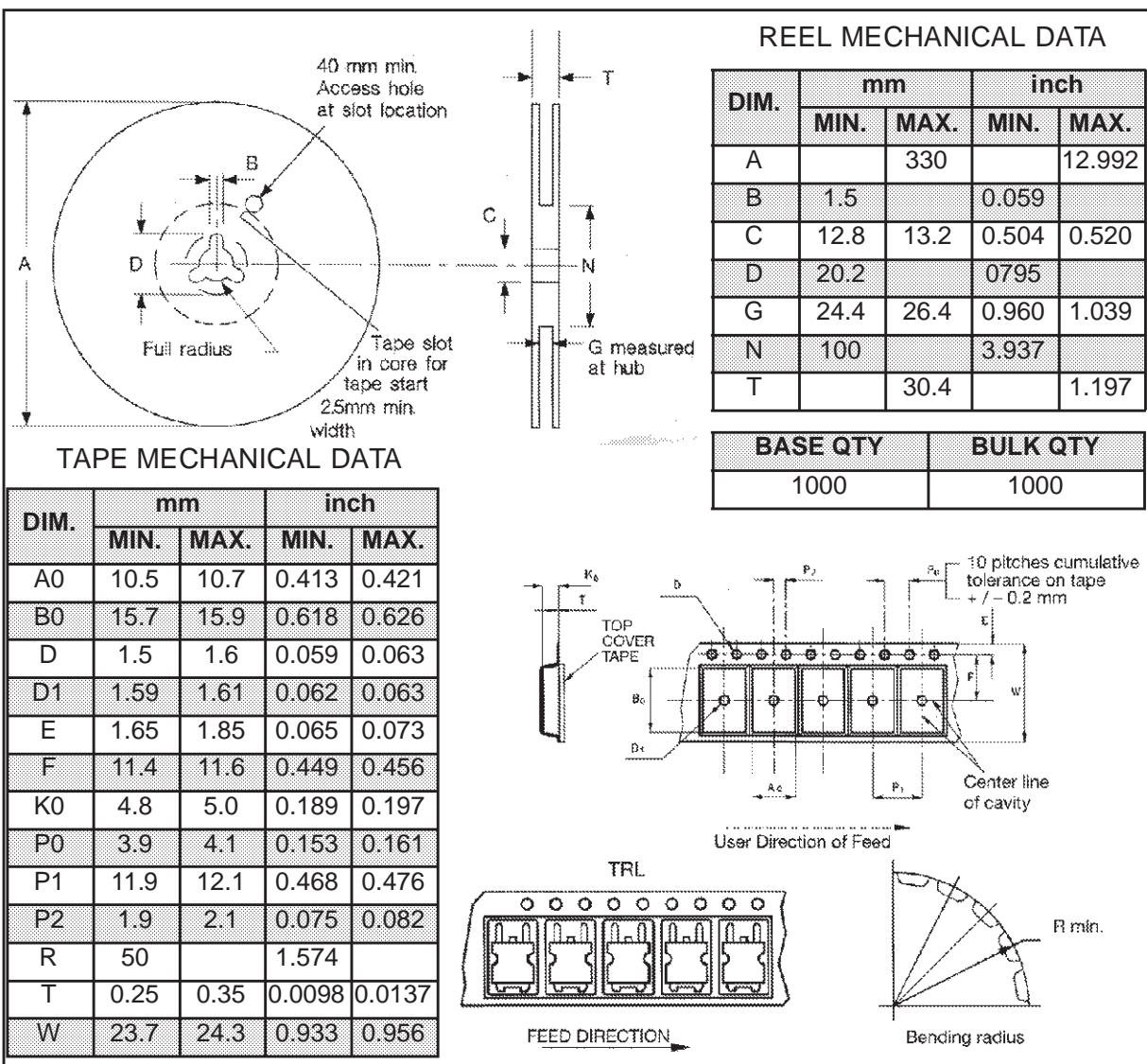


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### D<sup>2</sup>PAK MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
C	0.45		0.6	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1		8			0.315	
E	10		10.4	0.393		
E1		8.5			0.334	
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.625
L2	1.27		1.4	0.050		0.055
L3	1.4		1.75	0.055		0.068
M	2.4		3.2	0.094		0.126
R		0.4			0.015	
V2	0°		8°			



**D<sup>2</sup>PAK FOOTPRINT****TUBE SHIPMENT (no suffix)\*****TAPE AND REEL SHIPMENT (suffix "T4")\***

## **STGB10NB37LZ**

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